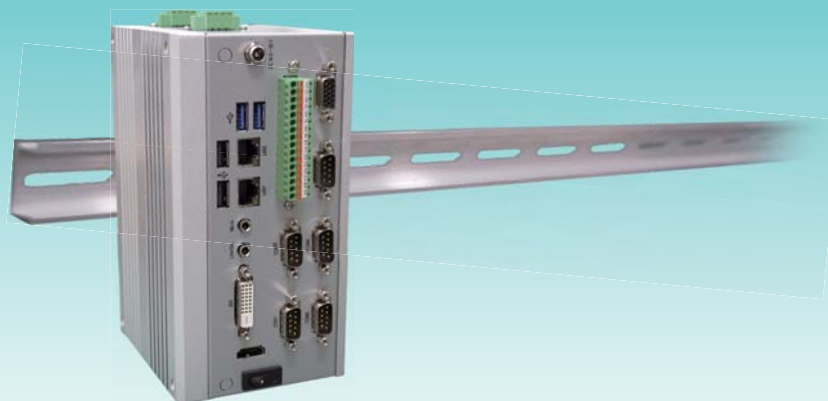


Embedded Solution

MIRO-3 (3 Layers) DIN-Rail Mounted Embedded Series



W / 31847CW



Excellent heat-dissipating DIN-Rail mounted System

Application :
Facility monitoring / Automation control / Transportation

DIN-Rail munted kit. (Option)

Technical Data :

• Dimension	90.9 H x 178 W x 116D mm
• Material	Aluminum
• Color	Silver
• Weight	1.75 Kg (Incl. M/B)
• Storage Space	1 x 2.5" HDD



M/B information: (Please refer to M/B specification)



CPU Type	M/B Model	VGA	DVI / HDMI	COM	LAN	USB	Audio	Operation Temp	
								mSATA	HDD
Intel® Bat-Trail E3815 / E3845	31380A/CW	1	HDMI	6	2	4	Line out / Mic-in	70°C	50°C
	31847CW	1	DVI & HDMI	5	2	4	Line out / Mic-in	70°C	50°C
Intel® Ivy Bridge 1047 UE 1.4GHz, i3, i7	31847NX	1	HDMI	2	1+4xPoE	3	Line out / Mic-in	70°C	50°C
	31268A/CW	1	-	6	2	4	Option	70°C	50°C

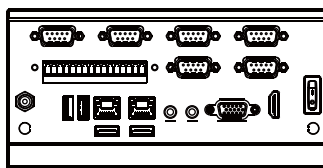
More Functions

3G / 4G	Wi-Fi	GPS	1 ~4 Video-IN	-
Optional LAN	Parallel Port	DC +9V~+36V	DIO	COM

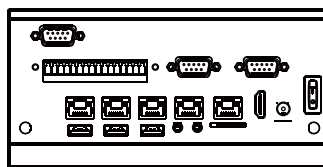
The above available functions outline the possibility with system, for more information please contact us.

Dimension

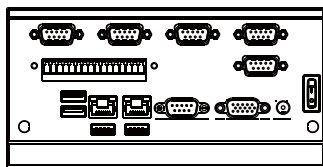
31380A



31847NX



31268CW



31847CW

